

# Low Side Chopper 600 V, 400 A, DIAP IGBT Power Module (Trench Field Stop IGBT)



Dual INT-A-PAK

## FEATURES

- Trench Field Stop IGBT technology
- 6  $\mu$ s short circuit capability
- Low  $V_{CE(on)}$
- Square RBSOA
- FRED Pt® antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- $Al_2O_3$  DBC
- UL pending
- Designed for industrial level
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

## BENEFITS

- Increased operating efficiency
- Direct mounting on heatsink
- Very low junction to case thermal resistance

## PRIMARY CHARACTERISTICS

| IGBT Q1                                |                  |
|----------------------------------------|------------------|
| $V_{CES}$                              | 600 V            |
| $I_C$ DC at 80 °C                      | 375 A            |
| $V_{CE(on)}$ (typical) at 400 A, 25 °C | 1.67 V           |
| CHOPPER DIODE D2                       |                  |
| $V_{RRM}$                              | 600 V            |
| $I_F$ DC at 80 °C                      | 278 A            |
| $V_{FM}$ (typical) at 400 A, 25 °C     | 1.61 V           |
| $t_{rr}$ at 400 A, 25 °C               | 141 ns           |
| ANTIPARALLEL DIODE D1                  |                  |
| $V_{RRM}$                              | 600 V            |
| $I_F$ DC at 80 °C                      | 142 A            |
| $V_{FM}$ (typical) at 200 A, 25 °C     | 1.56 V           |
| $t_{rr}$ at 200 A, 25 °C               | 120 ns           |
| Package                                | Dual INT-A-PAK   |
| Circuit                                | Low side chopper |

## ABSOLUTE MAXIMUM RATINGS

| PARAMETER                                     | SYMBOL      | TEST CONDITIONS                                                                               | MAX.        | UNITS              |
|-----------------------------------------------|-------------|-----------------------------------------------------------------------------------------------|-------------|--------------------|
| IGBT Q1                                       |             |                                                                                               |             |                    |
| Collector to emitter voltage                  | $V_{CES}$   |                                                                                               | 600         | V                  |
| Continuous collector current                  | $I_C^{(1)}$ | $T_C = 25\text{ }^{\circ}\text{C}$                                                            | 492         | A                  |
|                                               |             | $T_C = 80\text{ }^{\circ}\text{C}$                                                            | 375         |                    |
| Pulsed collector current                      | $I_{CM}$    | $T_p = 6\text{ ms}$ , square pulse                                                            | 850         |                    |
| Clamped inductive load current                | $I_{LM}$    |                                                                                               | 693         |                    |
| Gate to emitter voltage                       | $V_{GE}$    |                                                                                               | $\pm 20$    | V                  |
| Maximum power dissipation                     | $P_D$       | $T_C = 25\text{ }^{\circ}\text{C}$                                                            | 1363        | W                  |
|                                               |             | $T_C = 80\text{ }^{\circ}\text{C}$                                                            | 864         |                    |
| DIODE D2                                      |             |                                                                                               |             |                    |
| Chopper diode continuous forward current      | $I_F$       | $T_C = 25\text{ }^{\circ}\text{C}$                                                            | 374         | A                  |
|                                               |             | $T_C = 80\text{ }^{\circ}\text{C}$                                                            | 278         |                    |
| Single pulse forward current                  | $I_{FSM}$   | 10 ms sine or 6 ms rectangular pulse, $T_J = 25\text{ }^{\circ}\text{C}$                      | 1415        |                    |
| Maximum power dissipation                     | $P_D$       | $T_C = 25\text{ }^{\circ}\text{C}$                                                            | 652         | W                  |
|                                               |             | $T_C = 80\text{ }^{\circ}\text{C}$                                                            | 413         |                    |
| DIODE D1                                      |             |                                                                                               |             |                    |
| Antiparallel diode continuous forward current | $I_F$       | $T_C = 25\text{ }^{\circ}\text{C}$                                                            | 192         | A                  |
|                                               |             | $T_C = 80\text{ }^{\circ}\text{C}$                                                            | 142         |                    |
| Single pulse forward current                  | $I_{FSM}$   | 10 ms sine or 6 ms rectangular pulse, $T_J = 25\text{ }^{\circ}\text{C}$                      | 725         |                    |
| Maximum power dissipation                     | $P_D$       | $T_C = 25\text{ }^{\circ}\text{C}$                                                            | 312         | W                  |
|                                               |             | $T_C = 80\text{ }^{\circ}\text{C}$                                                            | 198         |                    |
| RMS isolation voltage                         | $V_{ISOL}$  | Any terminal to case ( $V_{RMS}\text{ t} = 1\text{ s}$ , $T_J = 25\text{ }^{\circ}\text{C}$ ) | 3500        | V                  |
| Storage temperature range                     | $T_{STG}$   |                                                                                               | -40 to 150  | $^{\circ}\text{C}$ |
| Operating junction temperature range          | $T_J$       |                                                                                               | -40 to +175 | $^{\circ}\text{C}$ |

### Note

(1) Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals

**ELECTRICAL SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                                    | SYMBOL                       | TEST CONDITIONS                                                                       | MIN. | TYP. | MAX.       | UNITS         |
|----------------------------------------------|------------------------------|---------------------------------------------------------------------------------------|------|------|------------|---------------|
| IGBT Q1                                      |                              |                                                                                       |      |      |            |               |
| Collector to emitter breakdown voltage       | $V_{BR(CES)}$                | $V_{GE} = 0\text{ V}$ , $I_C = 500\text{ }\mu\text{A}$                                | 600  | -    | -          | V             |
| Collector to emitter voltage                 | $V_{CE(on)}$                 | $V_{GE} = 15\text{ V}$ , $I_C = 300\text{ A}$                                         | -    | 1.48 | -          |               |
|                                              |                              | $V_{GE} = 15\text{ V}$ , $I_C = 400\text{ A}$                                         | -    | 1.67 | 2.0        |               |
|                                              |                              | $V_{GE} = 15\text{ V}$ , $I_C = 300\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$   | -    | 1.64 | -          |               |
|                                              |                              | $V_{GE} = 15\text{ V}$ , $I_C = 400\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$   | -    | 1.93 | -          |               |
| Gate threshold voltage                       | $V_{GE(th)}$                 | $V_{CE} = V_{GE}$ , $I_C = 6.4\text{ mA}$                                             | 4.6  | 5.9  | 7          |               |
|                                              |                              | $V_{CE} = V_{GE}$ , $I_C = 6.4\text{ mA}$ , $T_J = 125\text{ }^{\circ}\text{C}$       | -    | 4.6  | -          |               |
| Temperature coefficient of threshold voltage | $\Delta V_{GE(th)}/\Delta T$ | $V_{CE} = V_{GE}$ , $I_C = 6.4\text{ mA}$ , (25 °C to 125 °C)                         | -    | -13  | -          | mV/°C         |
| Forward transconductance                     | $g_{fe}$                     | $V_{CE} = 20\text{ V}$ , $I_C = 400\text{ A}$                                         | -    | 70   | -          | mS            |
| Transfer characteristics                     | $V_{GE}$                     | $V_{CE} = 20\text{ V}$ , $I_C = 400\text{ A}$                                         | -    | 9.1  | -          | V             |
| Collector to emitter leakage current         | $I_{CES}$                    | $V_{GE} = 0\text{ V}$ , $V_{CE} = 600\text{ V}$                                       | -    | 0.2  | 20         | $\mu\text{A}$ |
|                                              |                              | $V_{GE} = 0\text{ V}$ , $V_{CE} = 600\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$ | -    | 1.6  | -          | mA            |
| Gate to emitter leakage current              | $I_{GES}$                    | $V_{GE} = \pm 20\text{ V}$                                                            | -    | -    | $\pm 1200$ | nA            |
| DIODE D1                                     |                              |                                                                                       |      |      |            |               |
| Antiparallel diode forward voltage drop      | $V_{FM}$                     | $I_{FM} = 100\text{ A}$                                                               | -    | 1.32 | -          | V             |
|                                              |                              | $I_{FM} = 200\text{ A}$                                                               | -    | 1.56 | 1.82       |               |
|                                              |                              | $I_{FM} = 100\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                         | -    | 1.1  | -          |               |
|                                              |                              | $I_{FM} = 200\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                         | -    | 1.42 | -          |               |
| DIODE D2                                     |                              |                                                                                       |      |      |            |               |
| Blocking voltage                             | $V_{RRM}$                    | $I_R = 500\text{ }\mu\text{A}$                                                        | 600  | -    | -          | V             |
| Leakage current                              | $I_{RRM}$                    | $V_R = 600\text{ V}$                                                                  | -    | 0.2  | 15         | $\mu\text{A}$ |
|                                              |                              | $V_R = 600\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                            | -    | 2.8  | -          | mA            |
| Chopper diode forward voltage drop           | $V_{FM}$                     | $I_{FM} = 300\text{ A}$                                                               | -    | 1.48 | -          | V             |
|                                              |                              | $I_{FM} = 400\text{ A}$                                                               | -    | 1.61 | 1.92       |               |
|                                              |                              | $I_{FM} = 300\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                         | -    | 1.34 | -          |               |
|                                              |                              | $I_{FM} = 400\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                         | -    | 1.51 | -          |               |

**SWITCHING CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                          | SYMBOL       | TEST CONDITIONS                                                         | MIN. | TYP. | MAX. | UNITS |
|------------------------------------|--------------|-------------------------------------------------------------------------|------|------|------|-------|
| <b>IGBT Q1</b>                     |              |                                                                         |      |      |      |       |
| Total gate charge (turn-on)        | $Q_g$        | $I_C = 400\text{ A}$ , $V_{CC} = 480\text{ V}$ , $V_{GE} = 15\text{ V}$ | -    | 1970 | -    | nC    |
| Gate to emitter charge (turn-on)   | $Q_{ge}$     |                                                                         | -    | 144  | -    |       |
| Gate to collector charge (turn-on) | $Q_{gc}$     |                                                                         | -    | 1240 | -    |       |
| Turn-off switching energy          | $E_{off}$    | $R_{g(off)} = 1\text{ }\Omega$                                          | -    | 12.9 | -    | mJ    |
| Turn-off delay time                | $t_{d(off)}$ |                                                                         | -    | 594  | -    | ns    |
| Fall time                          | $t_f$        |                                                                         | -    | 77   | -    |       |
| Turn-on switching energy           | $E_{on}$     | $R_{g(on)} = 6.8\text{ }\Omega$                                         | -    | 12.8 | -    | mJ    |
| Turn-on delay time                 | $t_{d(on)}$  |                                                                         | -    | 337  | -    | ns    |
| Rise time                          | $t_r$        |                                                                         | -    | 197  | -    |       |
| Turn-off switching energy          | $E_{off}$    | $R_{g(off)} = 1\text{ }\Omega$                                          | -    | 14.7 | -    | mJ    |
| Turn-off delay time                | $t_{d(off)}$ |                                                                         | -    | 638  | -    | ns    |
| Fall time                          | $T_f$        |                                                                         | -    | 91   | -    |       |
| Turn-on switching energy           | $E_{on}$     | $R_{g(on)} = 6.8\text{ }\Omega$                                         | -    | 13.4 | -    | mJ    |
| Turn-on delay time                 | $t_{d(on)}$  |                                                                         | -    | 339  | -    | ns    |
| Rise time                          | $t_r$        |                                                                         | -    | 204  | -    |       |



| SWITCHING CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified) |                     |                                                                                                                                                           |                                                                                                                      |            |      |      |       |
|-------------------------------------------------------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|------------|------|------|-------|
| PARAMETER                                                                     | SYMBOL              | TEST CONDITIONS                                                                                                                                           |                                                                                                                      | MIN.       | TYP. | MAX. | UNITS |
| Turn-off switching energy                                                     | E <sub>off</sub>    | R <sub>g (off)</sub> = 1 Ω                                                                                                                                | I <sub>C</sub> = 400 A, V <sub>CC</sub> = 300 V,<br>V <sub>GE</sub> = ± 15 V, L = 500 μH,<br>T <sub>J</sub> = 25 °C  | -          | 19.3 | -    | mJ    |
| Turn-off delay time                                                           | t <sub>d(off)</sub> |                                                                                                                                                           |                                                                                                                      | -          | 593  | -    | ns    |
| Fall time                                                                     | t <sub>f</sub>      |                                                                                                                                                           |                                                                                                                      | -          | 82   | -    |       |
| Turn-on switching energy                                                      | E <sub>on</sub>     | R <sub>g (on)</sub> = 6.8 Ω                                                                                                                               |                                                                                                                      | -          | 15.6 | -    | mJ    |
| Turn-on delay time                                                            | t <sub>d(on)</sub>  |                                                                                                                                                           |                                                                                                                      | -          | 354  | -    | ns    |
| Rise time                                                                     | t <sub>r</sub>      |                                                                                                                                                           |                                                                                                                      | -          | 238  | -    |       |
| Turn-off switching energy                                                     | E <sub>off</sub>    | R <sub>g (off)</sub> = 1 Ω                                                                                                                                | I <sub>C</sub> = 400 A, V <sub>CC</sub> = 300 V,<br>V <sub>GE</sub> = ± 15 V, L = 500 μH,<br>T <sub>J</sub> = 125 °C | -          | 21.2 | -    | mJ    |
| Turn-off delay time                                                           | t <sub>d(off)</sub> |                                                                                                                                                           |                                                                                                                      | -          | 631  | -    | ns    |
| Fall time                                                                     | T <sub>f</sub>      |                                                                                                                                                           |                                                                                                                      | -          | 92   | -    |       |
| Turn-on switching energy                                                      | E <sub>on</sub>     | R <sub>g (on)</sub> = 6.8 Ω                                                                                                                               |                                                                                                                      | -          | 17.2 | -    | mJ    |
| Turn-on delay time                                                            | t <sub>d(on)</sub>  |                                                                                                                                                           |                                                                                                                      | -          | 365  | -    | ns    |
| Rise time                                                                     | t <sub>r</sub>      |                                                                                                                                                           |                                                                                                                      | -          | 246  | -    |       |
| Reverse bias safe operating area                                              | RBSOA               | T <sub>J</sub> = 175 °C, I <sub>C</sub> = 693 A, R <sub>g</sub> = 10 Ω,<br>V <sub>GE</sub> = 15 V to 0 V, V <sub>CC</sub> = 400 V, V <sub>p</sub> = 600 V |                                                                                                                      | Fullsquare |      |      |       |
| Short circuit safe operating area <sup>(1)(2)</sup>                           | SCSOA               | T <sub>J</sub> = 150 °C, V <sub>CC</sub> = 360 V, V <sub>GE</sub> = 15 V                                                                                  |                                                                                                                      | -          | -    | 6    | μs    |
| DIODE D2                                                                      |                     |                                                                                                                                                           |                                                                                                                      |            |      |      |       |
| Diode reverse recovery time                                                   | t <sub>rr</sub>     | I <sub>F</sub> = 400 A, V <sub>CC</sub> = 400 V, T <sub>J</sub> = 25 °C,<br>di/dt = 1000 A/μs,                                                            |                                                                                                                      | -          | 141  | -    | ns    |
| Diode peak reverse current                                                    | I <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 41   | -    | A     |
| Diode recovery charge                                                         | Q <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 3.2  | -    | μC    |
| Diode reverse recovery time                                                   | t <sub>rr</sub>     | I <sub>F</sub> = 400 A, V <sub>CC</sub> = 400 V, T <sub>J</sub> = 125 °C,<br>di/dt = 1000 A/μs,                                                           |                                                                                                                      | -          | 230  | -    | ns    |
| Diode peak reverse current                                                    | I <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 77   | -    | A     |
| Diode recovery charge                                                         | Q <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 10.2 | -    | μC    |
| DIODE D1                                                                      |                     |                                                                                                                                                           |                                                                                                                      |            |      |      |       |
| Diode reverse recovery time                                                   | t <sub>rr</sub>     | I <sub>F</sub> = 200 A, V <sub>R</sub> = 400 V, T <sub>J</sub> = 25 °C,<br>di/dt = 1000 A/μs,                                                             |                                                                                                                      | -          | 120  | -    | ns    |
| Diode peak reverse current                                                    | I <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 28   | -    | A     |
| Diode recovery charge                                                         | Q <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 2.2  | -    | μC    |
| Diode reverse recovery time                                                   | t <sub>rr</sub>     | I <sub>F</sub> = 200 A, V <sub>R</sub> = 400 V, T <sub>J</sub> = 125 °C,<br>di/dt = 1000 A/μs,                                                            |                                                                                                                      | -          | 165  | -    | ns    |
| Diode peak reverse current                                                    | I <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 90   | -    | A     |
| Diode recovery charge                                                         | Q <sub>rr</sub>     |                                                                                                                                                           |                                                                                                                      | -          | 9.1  | -    | μC    |

**Notes**

(1) Not subject to production test - verified by design / characterization

(2) Allowed number of short circuits: &lt; 1000; time between short circuits: &gt; 1 s

| THERMAL AND MECHANICAL SPECIFICATIONS                                           |                   |      |      |      |                             |  |
|---------------------------------------------------------------------------------|-------------------|------|------|------|-----------------------------|--|
| PARAMETER                                                                       | SYMBOL            | MIN. | TYP. | MAX. | UNITS                       |  |
| Operating junction temperature range                                            | $T_J$             | -40  | -    | 175  | $^{\circ}\text{C}$          |  |
| Storage temperature range                                                       | $T_{\text{Stg}}$  | -40  | -    | 150  |                             |  |
| Thermal resistance, junction to case per leg<br>Q1 IGBT<br>D1 diode<br>D2 diode | $R_{\text{thJC}}$ | -    | -    | 0.11 | $^{\circ}\text{C}/\text{W}$ |  |
|                                                                                 |                   | -    | -    | 0.48 |                             |  |
|                                                                                 |                   | -    | -    | 0.23 |                             |  |
| Thermal resistance, case to sink per module                                     | $R_{\text{thCS}}$ | -    | 0.05 | -    |                             |  |
| Mounting torque — Power terminal screw: M6<br>Mounting screw: M6                |                   | 2.5  | -    | 5.0  | Nm                          |  |
|                                                                                 |                   | 3.0  | -    | 5.0  |                             |  |
| Weight                                                                          |                   | -    | 300  | -    | g                           |  |

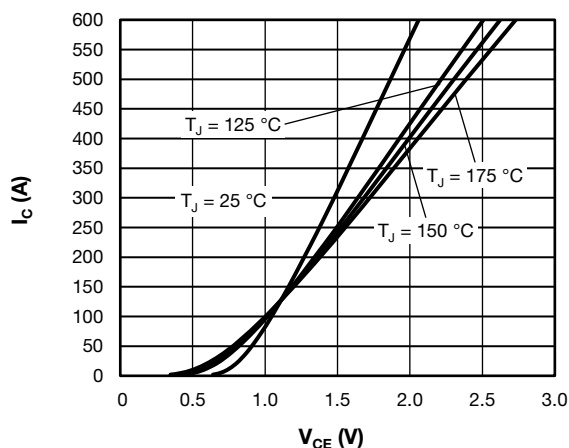


Fig. 1 - Typical IGBT Output Characteristics,  
 $V_{GE} = 15\text{ V}$

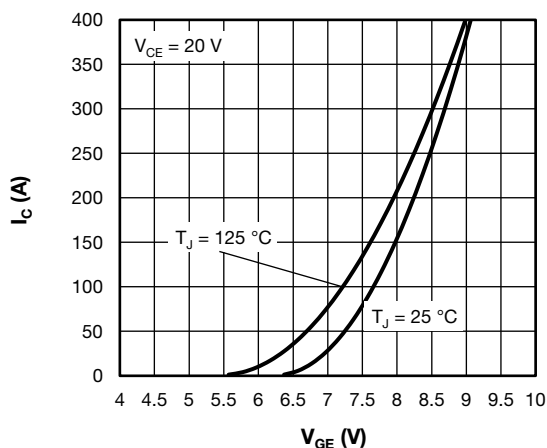


Fig. 4 - Typical IGBT Transfer Characteristics

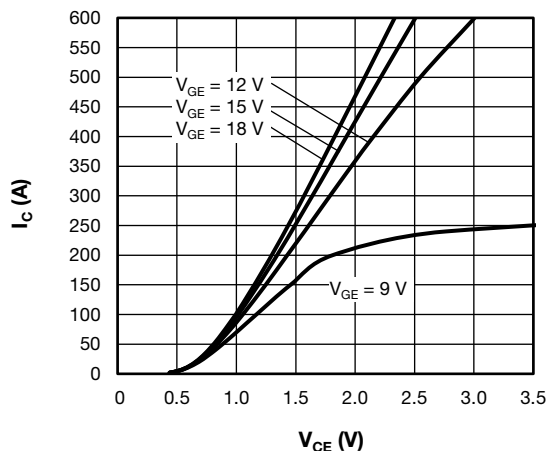


Fig. 2 - Typical IGBT Output Characteristics,  
 $T_J = 125\text{ °C}$

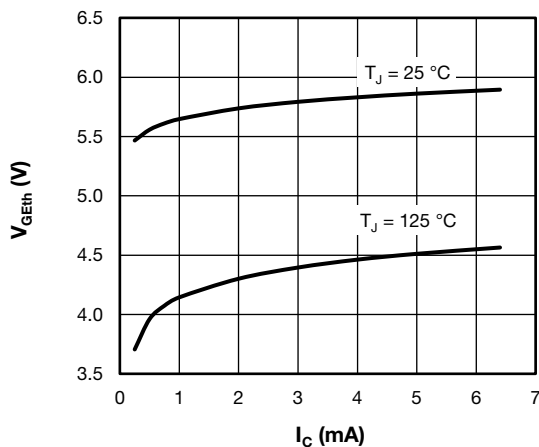


Fig. 5 - Typical IGBT Gate Threshold Voltage

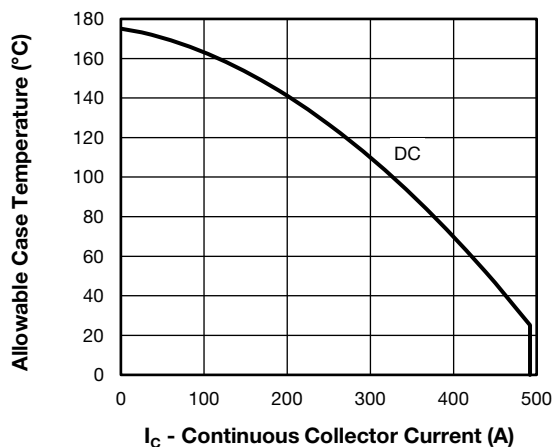


Fig. 3 - Maximum IGBT Continuous Collector Current vs.  
Case Temperature

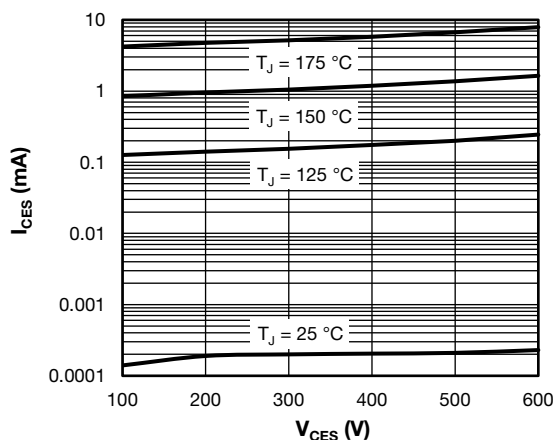


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

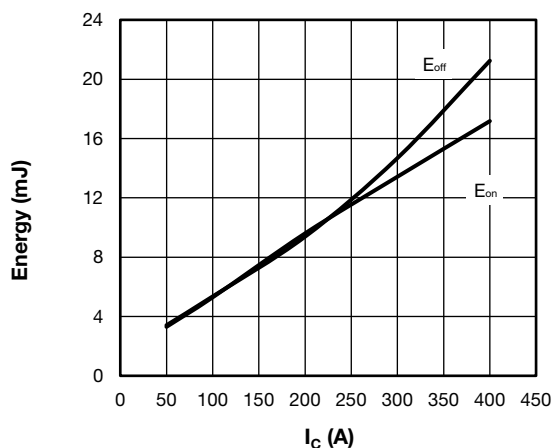


Fig. 7 - Typical IGBT Energy Loss vs.  $I_C$  with Freewheeling Diode  
 $T_J = 125^\circ\text{C}$ ,  $V_{CC} = 300\text{ V}$ ,  $R_{g(\text{on})} = 6.8\Omega$ ,  $R_{g(\text{off})} = 1\Omega$   
 $V_{GE} = +15\text{ V}/-15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

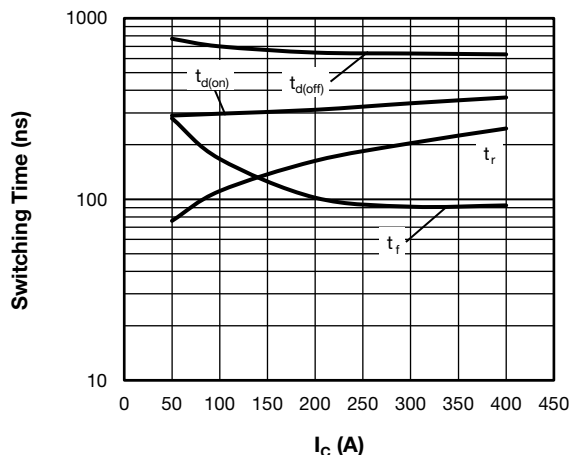


Fig. 8 - Typical Trench IGBT Switching Time vs.  $I_C$  with Freewheeling Diode  
 $T_J = 125^\circ\text{C}$ ,  $V_{CC} = 300\text{ V}$ ,  $R_{g(\text{on})} = 6.8\Omega$ ,  $R_{g(\text{off})} = 1\Omega$ ,  
 $V_{GE} = +15\text{ V}/-15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

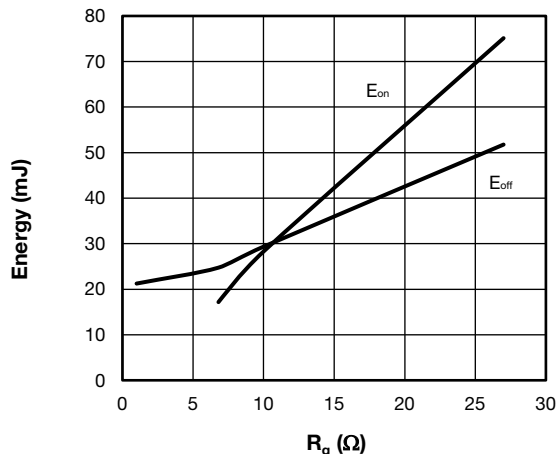


Fig. 9 - Typical Trench IGBT Energy Loss vs.  $R_g$

with Freewheeling Diode  
 $T_J = 125^\circ\text{C}$ ,  $V_{CC} = 300\text{ V}$ ,  $I_C = 400\text{ A}$ ,  $V_{GE} = +15\text{ V}/-15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

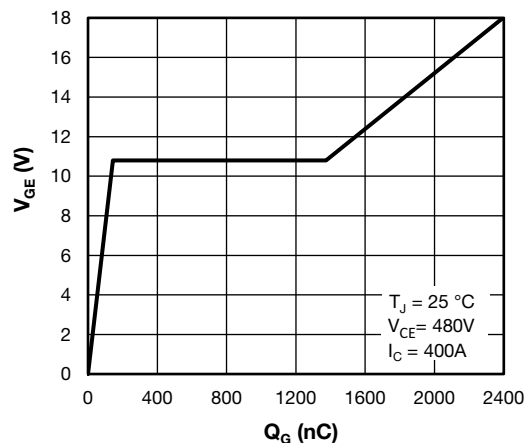


Fig. 10 - Typical Trench IGBT Gate Charge vs. Gate to Emitter Voltage

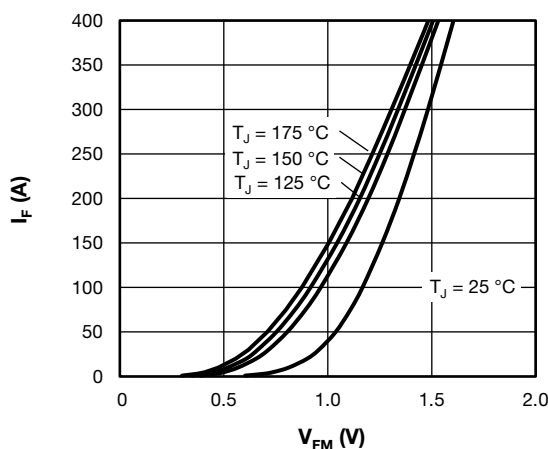


Fig. 11 - Typical D2 Diode Forward Characteristics

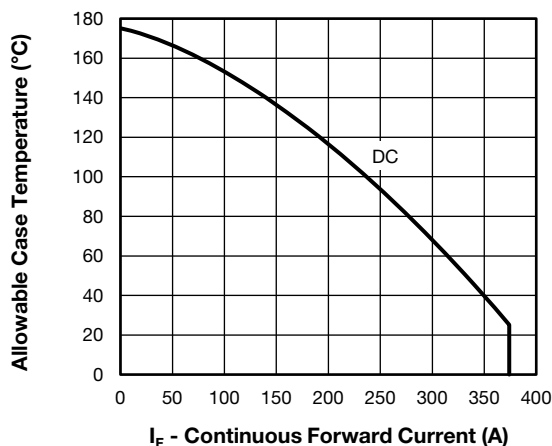


Fig. 12 - Maximum D2 Diode Continuous Forward Current vs. Case Temperature

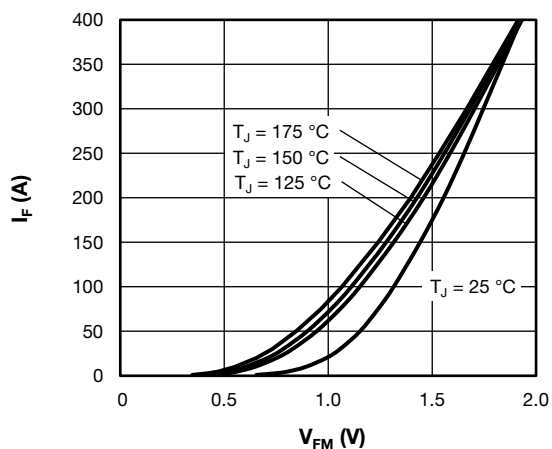


Fig. 13 - Typical D1 Diode Forward Characteristics

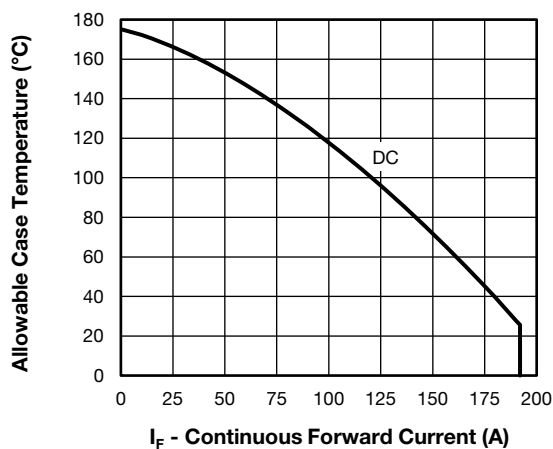


Fig. 14 - Maximum D1 Diode Continuous Forward Current vs. Case Temperature

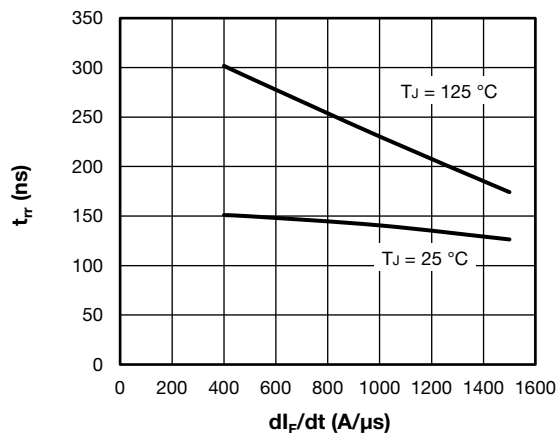


Fig. 15 - Typical Diode Reverse Recovery Time vs.  $dI_F/dt$

$I_F = 400\text{ A}$ ,  $V_{CC} = 400\text{ V}$

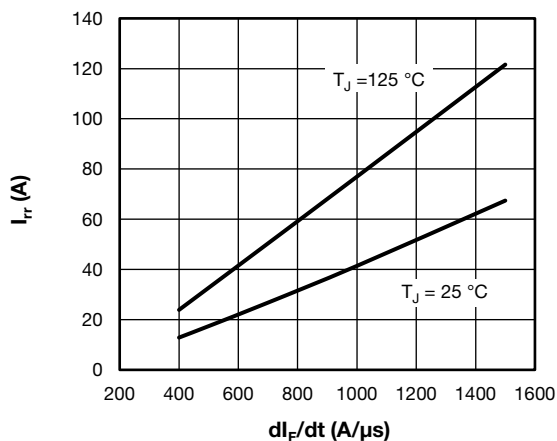


Fig. 16 - Typical Diode Reverse Recovery Current vs.  $dI_F/dt$   
 $I_F = 400\text{ A}$ ,  $V_{CC} = 400\text{ V}$

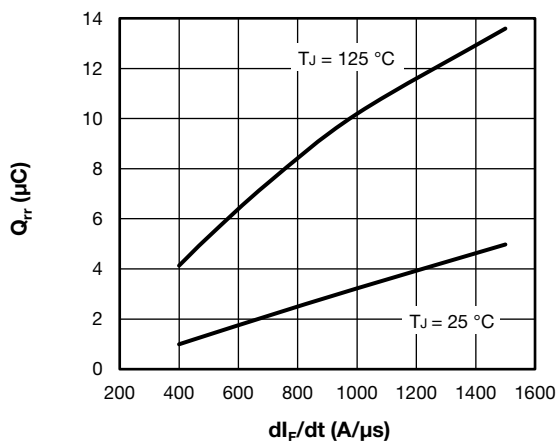


Fig. 17 - Typical Diode Reverse Recovery Charge vs.  $dI_F/dt$   
 $I_F = 400\text{ A}$ ,  $V_{CC} = 400\text{ V}$

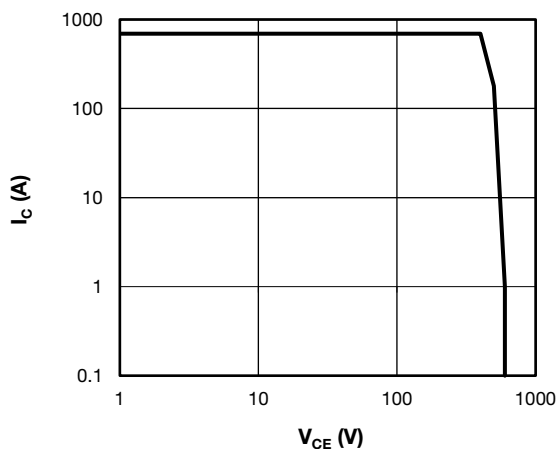


Fig. 18 - IGBT Reverse BIAS SOA  
 $T_J = 175^\circ\text{C}$ ,  $I_C = 693\text{ A}$ ,  $R_g = 10\ \Omega$ ,  $V_{GE} = +15\text{ V} / 0\text{ V}$ ,

$$V_{CC} = 400 \text{ V}, V_p = 600 \text{ V}$$

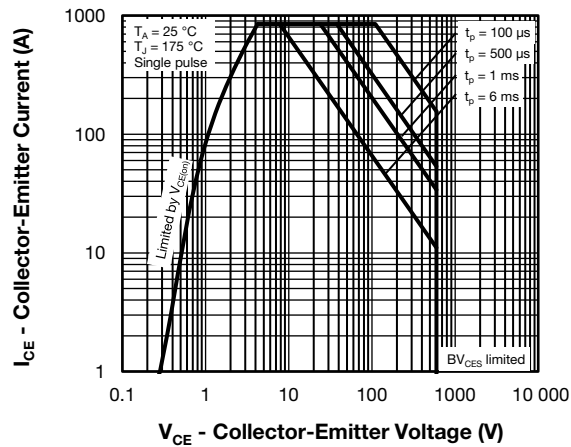
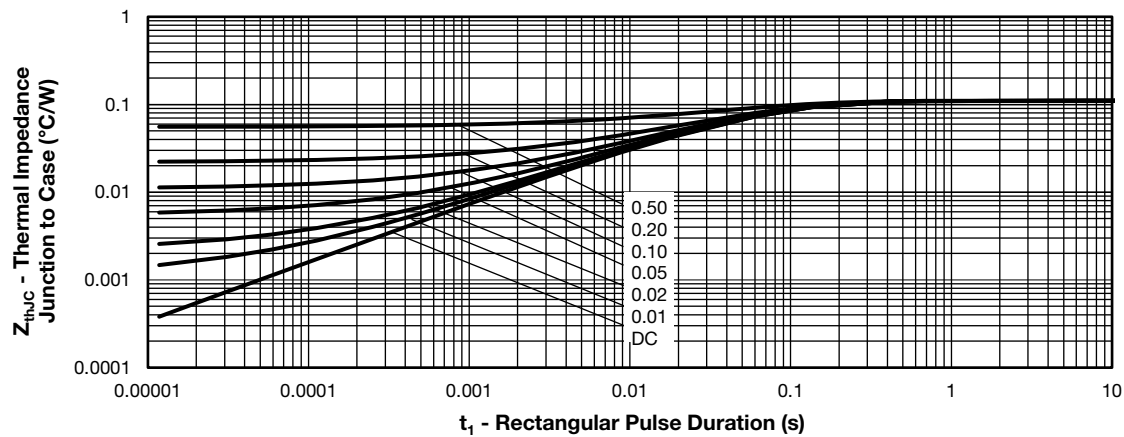
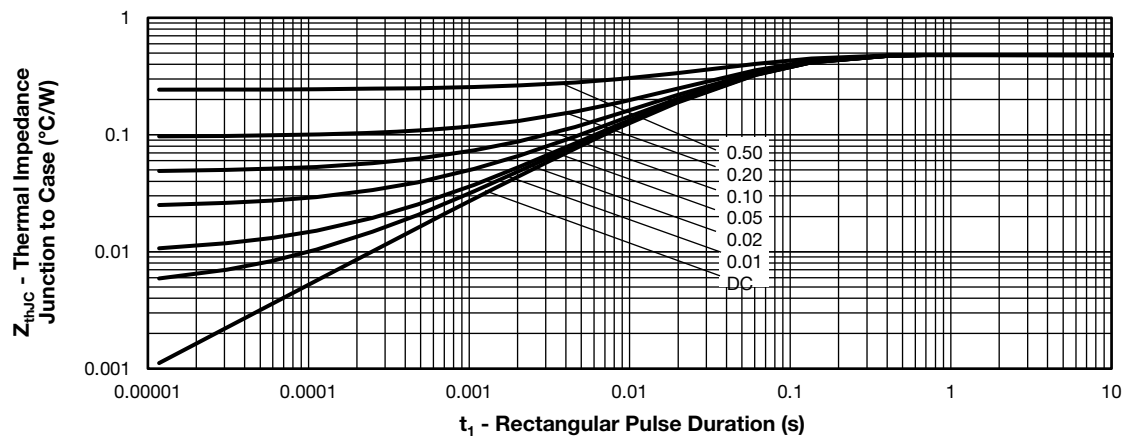


Fig. 19 - IGBT Safe Operating Area


Fig. 20 - Maximum IGBT Thermal Impedance  $Z_{thJC}$  Characteristics

Fig. 21 - Maximum D1 Diode Thermal Impedance  $Z_{thJC}$  Characteristics

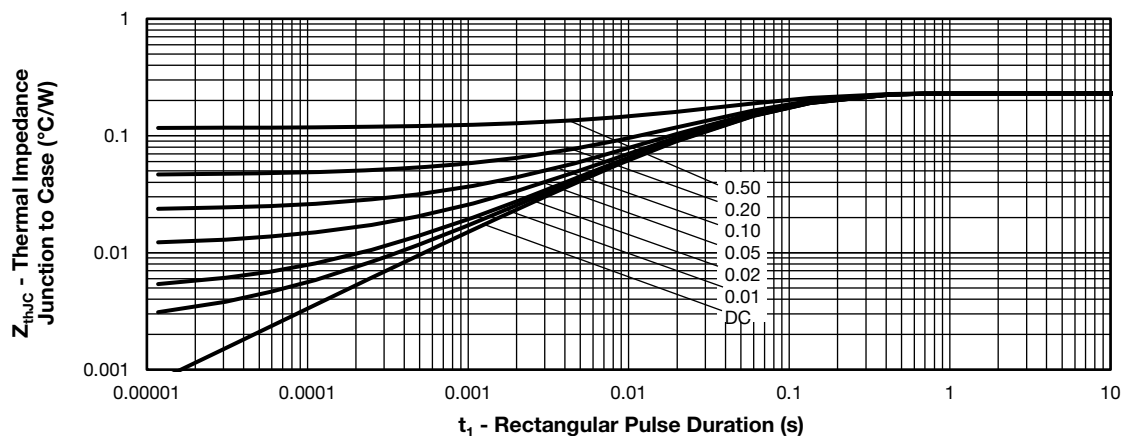


Fig. 22 - Maximum D2 Diode Thermal Impedance  $Z_{thJC}$  Characteristics

### ORDERING INFORMATION TABLE

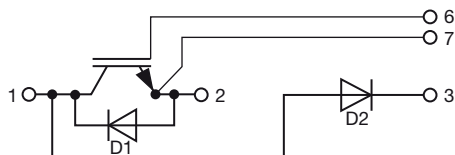
| Device code | VS- | G | T | 400 | L | H | 060 | N |
|-------------|-----|---|---|-----|---|---|-----|---|
|             | ①   | ② | ③ | ④   | ⑤ | ⑥ | ⑦   | ⑧ |
|             | 1   | 2 | 3 | 4   | 5 | 6 | 7   | 8 |
|             | -   | - | - | -   | - | - | -   | - |
|             | -   | - | - | -   | - | - | -   | - |
|             | -   | - | - | -   | - | - | -   | - |
|             | -   | - | - | -   | - | - | -   | - |
|             | -   | - | - | -   | - | - | -   | - |
|             | -   | - | - | -   | - | - | -   | - |
|             | -   | - | - | -   | - | - | -   | - |

- 1 - Vishay Semiconductors product
- 2 - Insulated gate bipolar transistor (IGBT)
- 3 - T = Trench Field Stop IGBT technology
- 4 - Current rating (400 = 400 A)
- 5 - Circuit configuration (L = low side chopper)
- 6 - Package indicator (H = Dual INT-A-PAK)
- 7 - Voltage rating (060 = 600 V)
- 8 - N = none

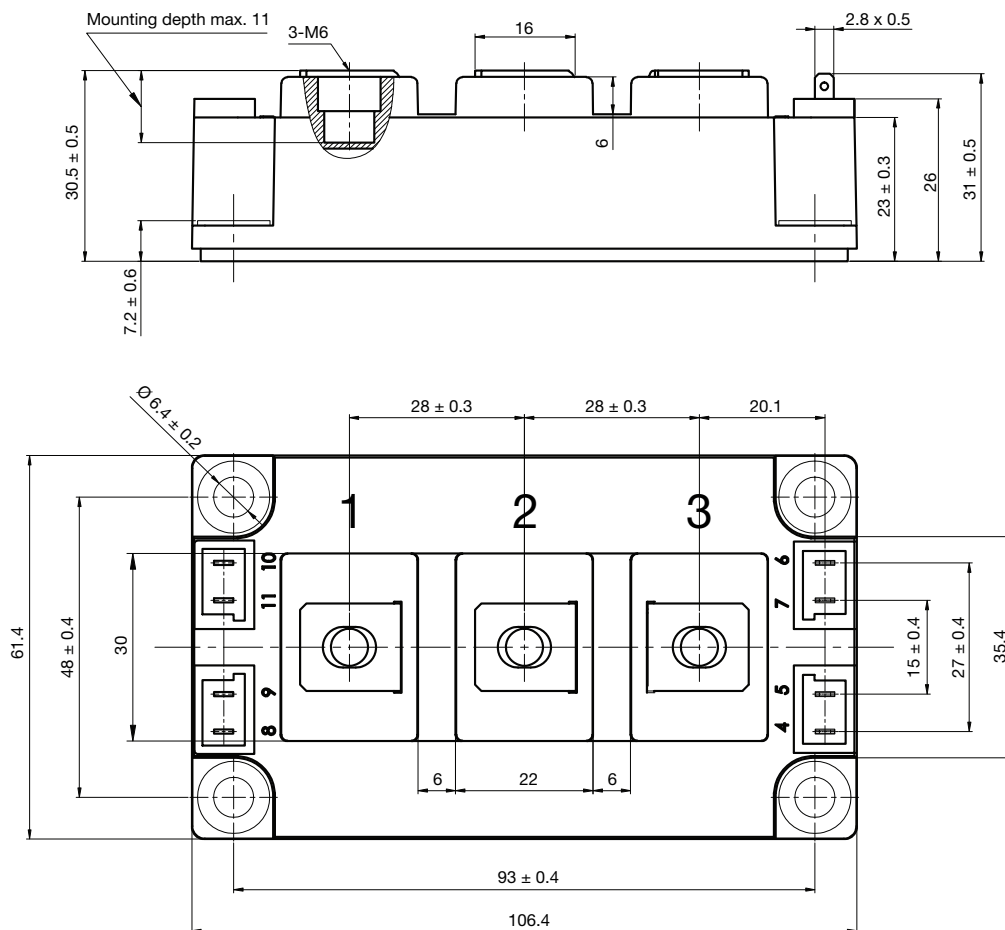
| LINKS TO RELATED DOCUMENTS |                                                                        |
|----------------------------|------------------------------------------------------------------------|
| Dimensions                 | <a href="http://www.vishay.com/doc?95525">www.vishay.com/doc?95525</a> |
| Application Note           | <a href="http://www.vishay.com/doc?95553">www.vishay.com/doc?95553</a> |



## CIRCUIT CONFIGURATION



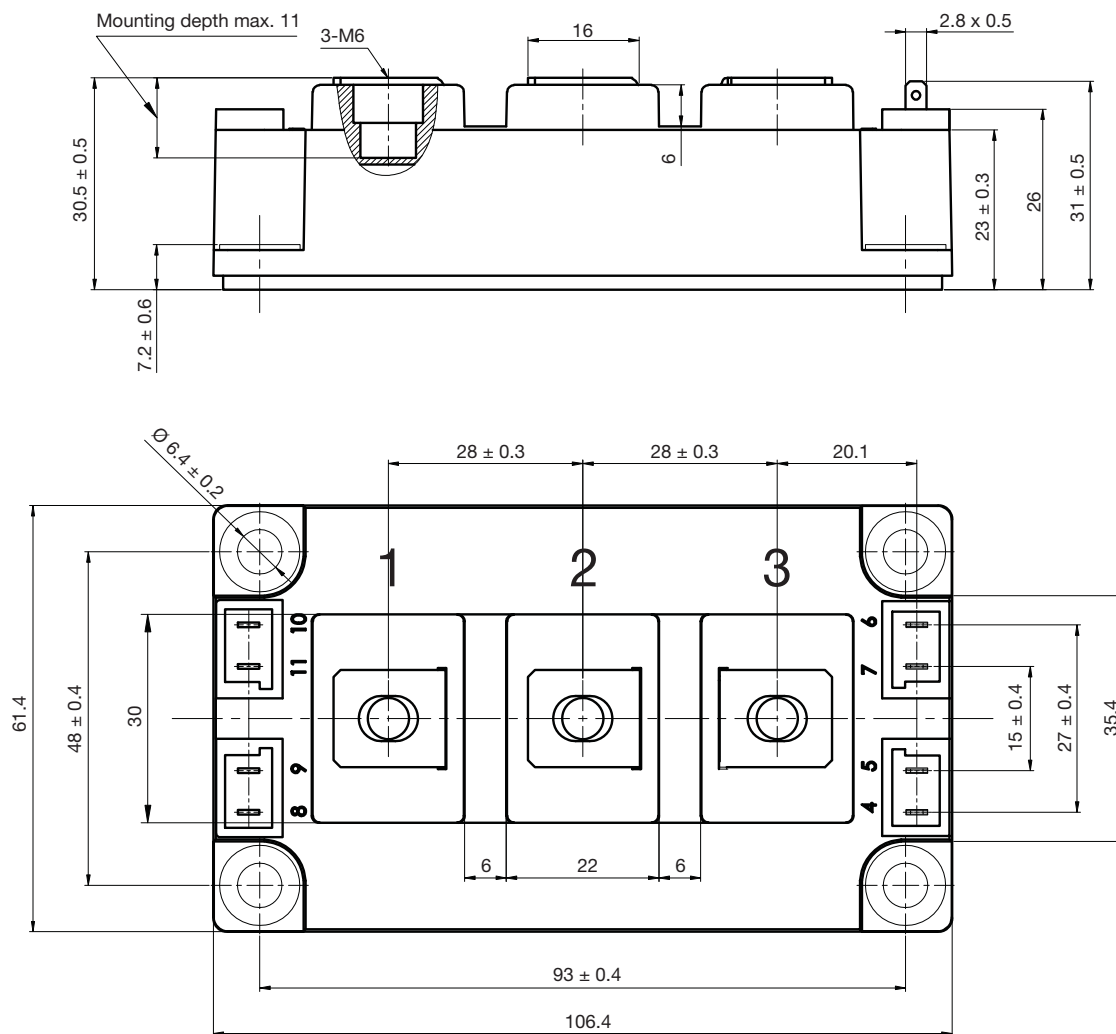
## DIMENSIONS in millimeters





## Double INT-A-PAK

**DIMENSIONS** in millimeters (inches)





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